

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>SANG HYUN HONG</td> <td>10/28/2013</td> </tr> <tr> <td>SANG HWA LEE</td> <td>10/28/2013</td> </tr> <tr> <td>JONG CHEOL LIM</td> <td>10/28/2013</td> </tr> <tr> <td>YOO JIN JUNG</td> <td>10/28/2013</td> </tr> <tr> <td>SANG KYUN LIM</td> <td>10/28/2013</td> </tr> </tbody> </table>		Name	Execution Date	SANG HYUN HONG	10/28/2013	SANG HWA LEE	10/28/2013	JONG CHEOL LIM	10/28/2013	YOO JIN JUNG	10/28/2013	SANG KYUN LIM	10/28/2013
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YOO JIN JUNG	10/28/2013												
SANG KYUN LIM	10/28/2013												
RECEIVING PARTY DATA													
Name:	Cheil Industries Inc.												
Street Address:	290 Gongdan-dong												
Internal Address:	Gumi-si, Gyeongsangbuk-do												
City:	Gumi-si												
State/Country:	KOREA, REPUBLIC OF												
Postal Code:	730-710												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>14067139</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	14067139								
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CORRESPONDENCE DATA													
Fax Number:	(704)945-6735												
Phone:	704-945-6700												
Email:	docket@ahpapatent.com												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	MELISSA B. PENDLETON												
Address Line 1:	11610 N. COMMUNITY HOUSE ROAD												
Address Line 2:	SUITE 200												
Address Line 4:	CHARLOTTE, NORTH CAROLINA 28277												
ATTORNEY DOCKET NUMBER:	6250.214												

NAME OF SUBMITTER:	MELISSA B. PENDLETON
Signature:	/Melissa B. Pendleton/
Date:	10/30/2013
Total Attachments: 4 source=AssignmentUSPTO#page1.tif source=AssignmentUSPTO#page2.tif source=AssignmentUSPTO#page3.tif source=AssignmentUSPTO#page4.tif	

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)
Sang Hyun Hong
Sang Hwa Lee
Jong Cheol Lim
Yoo Jin Jung
Sang Kyun Lim
Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)
Name: Cheil Industries Inc.
Internal Address: _____
Street Address: 290 Gongdan-dong
City: Gumi-si
State: Gyeongsangbuk-do
Country: South Korea Zip: 730-710
Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):
Execution Date(s) October 28, 2013
 Assignment Merger
 Security Agreement Change of Name
 Joint Research Agreement
 Government Interest Assignment
 Executive Order 9424, Confirmatory License
 Other _____

4. Application or patent number(s): This document is being filed together with a new application.
A. Patent Application No.(s)
14/067,139
B. Patent No.(s)
Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:
Name: Additon, Higgins, Pendleton & Ashe, P.A.
Internal Address: _____
Street Address: 11610 N. Community House Road, Suite 200
City: Charlotte
State: NC Zip: 28277-2199
Phone Number: 704-945-6700
Fax Number: 704-945-6735
Email Address: _____

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
 Authorized to be charged by credit card
 Authorized to be charged to deposit account
 Enclosed
 None required (government interest not affecting title)

8. Payment Information
a. Credit Card Last 4 Numbers _____
Expiration Date _____
b. Deposit Account Number _____
Authorized User Name _____

9. Signature: /Melissa B. Pendleton/ October 30, 2013
Signature Date
Melissa B. Pendleton
Name of Person Signing
Total number of pages including cover sheet, attachments, and documents: 4

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450

ASSIGNMENT

WHEREAS, I, **Sang Hyun Hong**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Sang Hwa Lee**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Jong Cheol Lim**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; **Yoo Jin Jung**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea; and **Sang Kyun Lim**, a Korean citizen, with a mailing address of Cheil Industries Inc., 332-2, Gocheon-dong, Uiwang-si, Gyeonggi-do, Republic of Korea (hereinafter referred to as "ASSIGNOR"), am a joint inventor of certain new and useful improvements (hereinafter collectively referred to as "INVENTION") in *Polyamide Resin Composition Having Excellent Photostability and Discoloration Resistance*, for which an application for United States Letters Patent is being filed concurrently herewith and which application claims priority from a Korean application filed on February 1, 2013, under Serial No. 10-2013-0012017, all applications listed above being hereinafter referred to as the "APPLICATION"; and

WHEREAS, Cheil Industries Inc., a Korean corporation (hereinafter referred to as "ASSIGNEE"), having a principal place of business at 290 Gongdan-dong, Gumi-si, Gyeongsangbuk-do 730-710, Republic of Korea, has acquired the equitable right, title, and interest—and is desirous of acquiring any remaining right, title, and interest—in and to said INVENTION as described in said APPLICATION, and in and to any and all Letters Patent that

shall be granted with respect to said INVENTION in the United States of America and all foreign countries;

NOW, THEREFORE, be it known that for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, have sold, assigned, transferred, and conveyed unto said ASSIGNEE, its successors and assigns, my equitable right, title, and interest—and by these presents do hereby sell, assign, transfer, and convey unto said ASSIGNEE, its successors and assigns any remaining right, title, and interest—in and to said INVENTION and APPLICATION, in and to any and all continuations, continuations-in-part, or divisions thereof, and in and to any and all Letters Patent of the United States of America and all foreign countries or reissues, reexaminations, or extensions thereof that may be granted therefore or thereon, for the full term for which said Letters Patent may be granted, together with the right to claim the priority of said APPLICATION in all foreign countries in accordance with international treaties and conventions, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by me if an assignment and sale had not been made.

I acknowledge that at the time the INVENTION was made, the INVENTION was subject to an obligation of assignment to said ASSIGNEE. I further acknowledge that said ASSIGNEE has the sole right to determine patent prosecution strategies with respect to said INVENTION and all corresponding applications, and hereby request that Letters Patent be issued in accordance with this assignment.

I further covenant and agree to bind my heirs, legal representatives, and assigns, promptly to communicate to said ASSIGNEE or its representatives any facts known to me relating to said INVENTION, to testify in any interference or legal

proceedings involving said INVENTION, to execute any additional papers that may be requested to confirm the right of the ASSIGNEE, its representatives, successors or assigns to secure patent or similar protection for said INVENTION in all countries and to vest in the ASSIGNEE complete title to said INVENTION and Letters Patent, without further compensation, but at the expense of said ASSIGNEE, its successors, assigns and other legal representatives.

As the below named inventor, I hereby declare:

The application for United States Letters Patent being filed concurrently herewith was made or authorized to be made by me.

I believe that I am the original or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in the declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

IN WITNESS WHEREOF, I have hereunto signed my name on the day and year set forth below.

<u>10. 28</u> , 2013	<u>홍상현</u> Sang Hyun Hong
<u>10. 28</u> , 2013	<u>이삼화</u> Sang Hwa Lee
<u>10. 28</u> , 2013	<u>임정철</u> Jong Cheol Lim
<u>10. 28</u> , 2013	<u>정유진</u> Yoo Jin Jung
<u>10. 28</u> , 2013	<u>임상권</u> Sang Kyun Lim